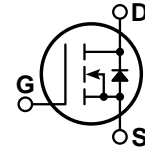


## POWER MOS V®

Power MOS V® is a new generation of high voltage N-Channel enhancement mode power MOSFETs. This new technology minimizes the JFET effect, increases packing density and reduces the on-resistance. Power MOS V® also achieves faster switching speeds through optimized gate layout.



- **Faster Switching**
- **100% Avalanche Tested**
- **Lower Leakage**
- **Popular SOT-227 Package**



### MAXIMUM RATINGS

All Ratings:  $T_C = 25^\circ\text{C}$  unless otherwise specified.

| Symbol         | Parameter  | APT10M07JVR | UNIT                |
|----------------|--|-------------|---------------------|
| $V_{DSS}$      | Drain-Source Voltage   | 100         | Volts               |
| $I_D$          | Continuous Drain Current @ $T_C = 25^\circ\text{C}$            | 225         | Amps                |
| $I_{DM}$       | Pulsed Drain Current <sup>①</sup>                              | 900         |                     |
| $V_{GS}$       | Gate-Source Voltage Continuous                                 | $\pm 30$    | Volts               |
| $V_{GSM}$      | Gate-Source Voltage Transient                                  | $\pm 40$    |                     |
| $P_D$          | Total Power Dissipation @ $T_C = 25^\circ\text{C}$             | 700         | Watts               |
|                | Linear Derating Factor   | 5.6         | W/ $^\circ\text{C}$ |
| $T_J, T_{STG}$ | Operating and Storage Junction Temperature Range               | -55 to 150  | $^\circ\text{C}$    |
| $T_L$          | Lead Temperature: 0.063" from Case for 10 Sec.                 | 300         |                     |
| $I_{AR}$       | Avalanche Current <sup>①</sup> (Repetitive and Non-Repetitive) | 225         | Amps                |
| $E_{AR}$       | Repetitive Avalanche Energy <sup>①</sup>                       | 50          | mJ                  |
| $E_{AS}$       | Single Pulse Avalanche Energy <sup>④</sup>                     | 3600        |                     |

### STATIC ELECTRICAL CHARACTERISTICS

| Symbol       | Characteristic / Test Conditions   | MIN | TYP | MAX       | UNIT          |
|--------------|--|-----|-----|-----------|---------------|
| $BV_{DSS}$   | Drain-Source Breakdown Voltage ( $V_{GS} = 0V, I_D = 250\mu\text{A}$ )                             | 100 |     |           | Volts         |
| $I_{D(on)}$  | On State Drain Current <sup>②</sup> ( $V_{DS} > I_{D(on)} \times R_{DS(on)}$ Max, $V_{GS} = 10V$ ) | 225 |     |           | Amps          |
| $R_{DS(on)}$ | Drain-Source On-State Resistance <sup>②</sup> ( $V_{GS} = 10V, 0.5 I_{D[Cont.]}$ )                 |     |     | 0.007     | Ohms          |
| $I_{DSS}$    | Zero Gate Voltage Drain Current ( $V_{DS} = V_{DSS}, V_{GS} = 0V$ )                                |     |     | 250       | $\mu\text{A}$ |
|              | Zero Gate Voltage Drain Current ( $V_{DS} = 0.8 V_{DSS}, V_{GS} = 0V, T_C = 125^\circ\text{C}$ )   |     |     | 1000      |               |
| $I_{GSS}$    | Gate-Source Leakage Current ( $V_{GS} = \pm 30V, V_{DS} = 0V$ )                                    |     |     | $\pm 100$ | nA            |
| $V_{GS(th)}$ | Gate Threshold Voltage ( $V_{DS} = V_{GS}, I_D = 5.0\text{mA}$ )                                   | 2   |     | 4         | Volts         |

 **CAUTION:** These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

**USA**  
405 S.W. Columbia Street

**EUROPE**  
Avenue J.F. Kennedy Bât B4 Parc Cadéra Nord

APT Website - <http://www.advancedpower.com>

Bend, Oregon 97702-1035

Phone: (541) 382-8028

FAX: (541) 388-0364

F-33700 Merignac - France

Phone: (33) 5 57 92 15 15

FAX: (33) 5 56 47 97 61

**DYNAMIC CHARACTERISTICS**

**APT10M07JVR**

| Symbol       | Characteristic               | Test Conditions  | MIN | TYP   | MAX   | UNIT |
|--------------|------------------------------|--|-----|-------|-------|------|
| $C_{iss}$    | Input Capacitance            | $V_{GS} = 0V$<br>$V_{DS} = 25V$<br>$f = 1 \text{ MHz}$   |     | 18000 | 21600 | pF   |
| $C_{oss}$    | Output Capacitance           |  |     | 6800  | 9500  |      |
| $C_{rss}$    | Reverse Transfer Capacitance |  |     | 2800  | 4200  |      |
| $Q_g$        | Total Gate Charge ③          | $V_{GS} = 10V$<br>$V_{DD} = 0.5 V_{DSS}$<br>$I_D = 100A @ 25^\circ C$                              |     | 700   | 1050  | nC   |
| $Q_{gs}$     | Gate-Source Charge           |  |     | 130   | 195   |      |
| $Q_{gd}$     | Gate-Drain ("Miller") Charge |  |     | 300   | 435   |      |
| $t_{d(on)}$  | Turn-on Delay Time           | $V_{GS} = 15V$<br>$V_{DD} = 0.5 V_{DSS}$<br>$I_D = I_{D[Cont.]} @ 25^\circ C$<br>$R_G = 0.6\Omega$ |     | 25    | 50    | ns   |
| $t_r$        | Rise Time                    |  |     | 60    | 120   |      |
| $t_{d(off)}$ | Turn-off Delay Time          |  |     | 80    | 120   |      |
| $t_f$        | Fall Time                    |  |     | 20    | 40    |      |

**SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS**

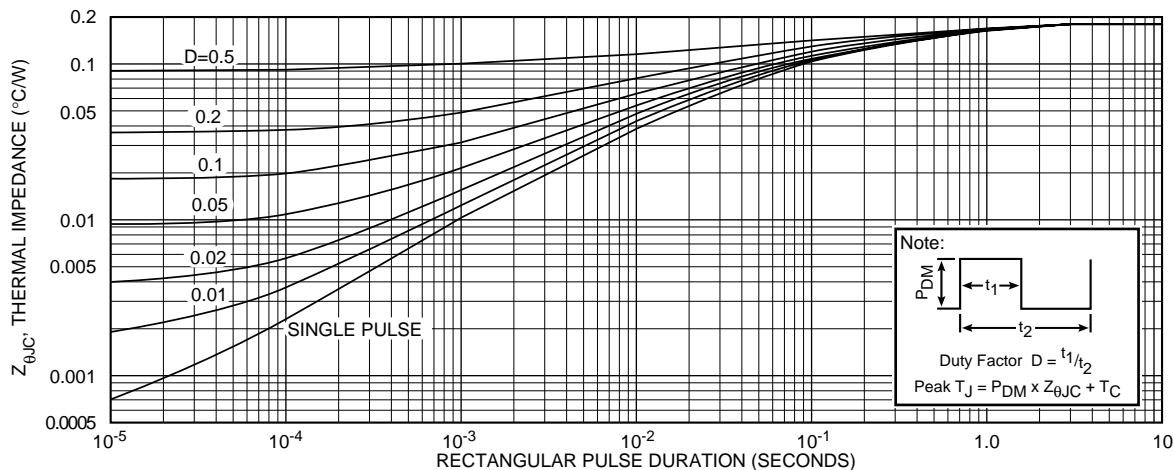
| Symbol   | Characteristic / Test Conditions  | MIN | TYP | MAX | UNIT    |
|----------|---|-----|-----|-----|---------|
| $I_S$    | Continuous Source Current (Body Diode)                                  |     |     | 225 | Amps    |
| $I_{SM}$ | Pulsed Source Current ① (Body Diode)                                    |     |     | 900 |         |
| $V_{SD}$ | Diode Forward Voltage ② ( $V_{GS} = 0V, I_S = -I_{D[Cont.]}$ )          |     |     | 1.3 | Volts   |
| $t_{rr}$ | Reverse Recovery Time ( $I_S = -I_{D[Cont.]}, di_S/dt = 100A/\mu s$ )   |     | 330 |     | ns      |
| $Q_{rr}$ | Reverse Recovery Charge ( $I_S = -I_{D[Cont.]}, di_S/dt = 100A/\mu s$ ) |     | 3   |     | $\mu C$ |

**THERMAL/PACKAGE CHARACTERISTICS**

| Symbol          | Characteristic  | MIN  | TYP | MAX  | UNIT         |
|-----------------|---|------|-----|------|--------------|
| $R_{\theta JC}$ | Junction to Case  |      |     | 0.18 | $^\circ C/W$ |
| $R_{\theta JA}$ | Junction to Ambient   |      |     | 40   |              |
| $V_{Isolation}$ | RMS Voltage (50-60 Hz Sinusoidal Waveform From Terminals to Mounting Base for 1 Min.) | 2500 |     |      | Volts        |
| Torque          | Maximum Torque for Device Mounting Screws and Electrical Terminations.                |      |     | 13   | lb•in        |

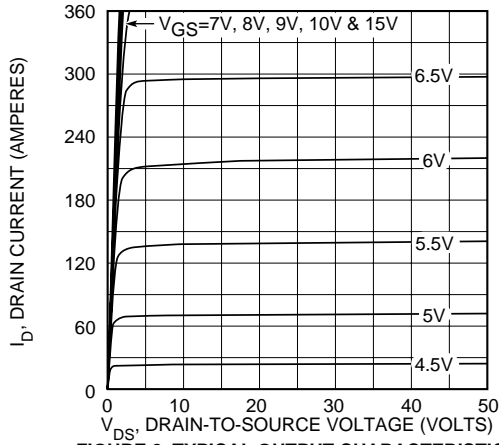
- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Pulse Test: Pulse width < 380  $\mu s$ , Duty Cycle < 2%
- ③ See MIL-STD-750 Method 3471
- ④ Starting  $T_j = +25^\circ C$ ,  $L = 142\mu H$ ,  $R_G = 25\Omega$ , Peak  $I_L = 225A$

**APT Reserves the right to change, without notice, the specifications and information contained herein.**

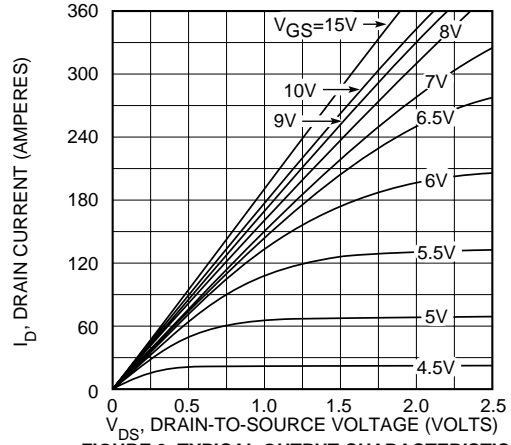


**FIGURE 1, MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs PULSE DURATION**

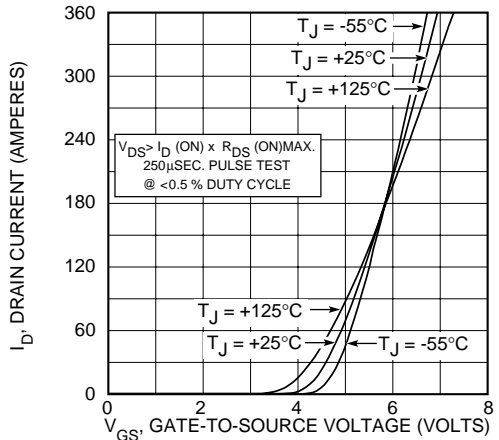
**APT10M07JVR**



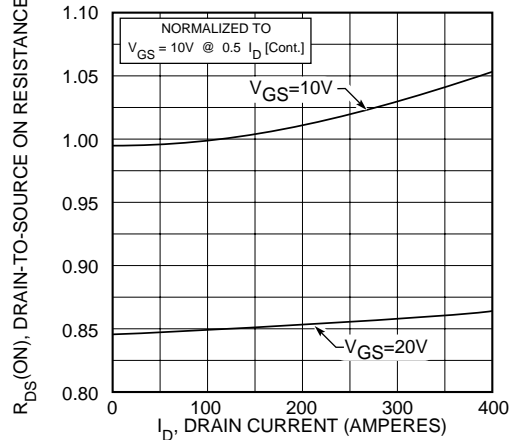
**FIGURE 2, TYPICAL OUTPUT CHARACTERISTICS**



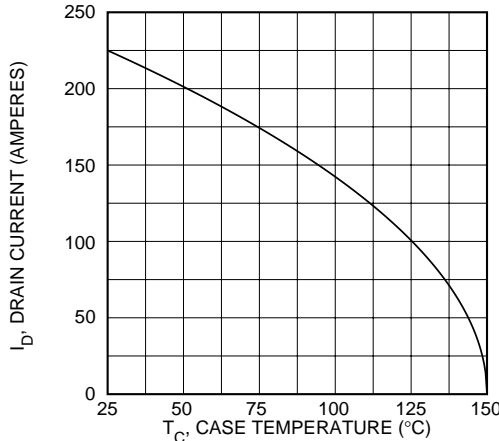
**FIGURE 3, TYPICAL OUTPUT CHARACTERISTICS**



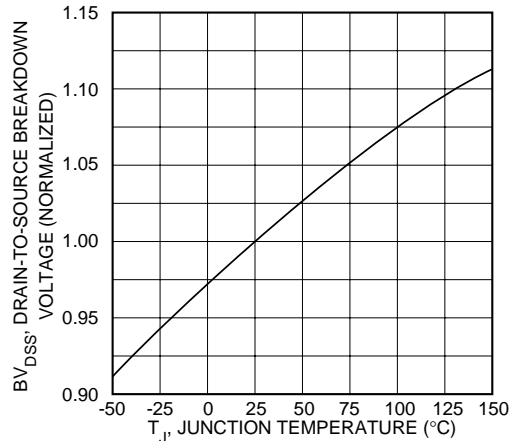
**FIGURE 4, TYPICAL TRANSFER CHARACTERISTICS**



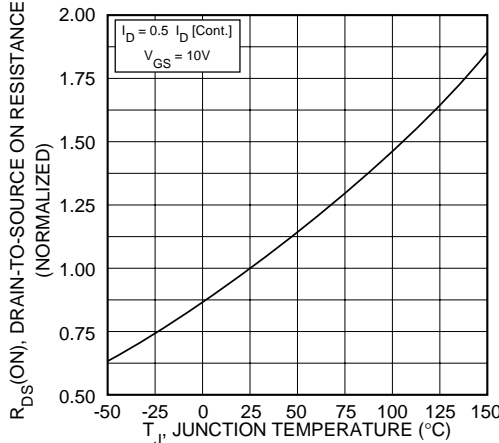
**FIGURE 5,  $R_{DS(ON)}$  vs DRAIN CURRENT**



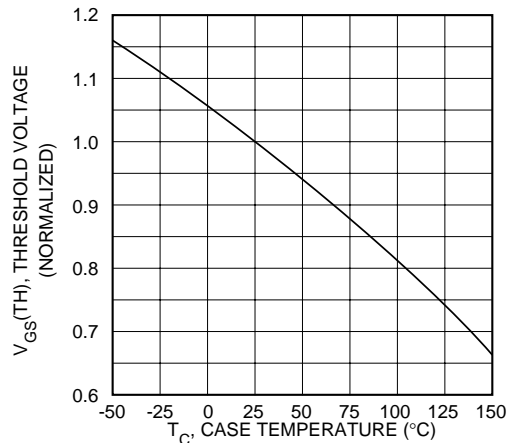
**FIGURE 6, MAXIMUM DRAIN CURRENT vs CASE TEMPERATURE**



**FIGURE 7, BREAKDOWN VOLTAGE vs TEMPERATURE**



**FIGURE 8, ON-RESISTANCE vs. TEMPERATURE**



**FIGURE 9, THRESHOLD VOLTAGE vs TEMPERATURE**

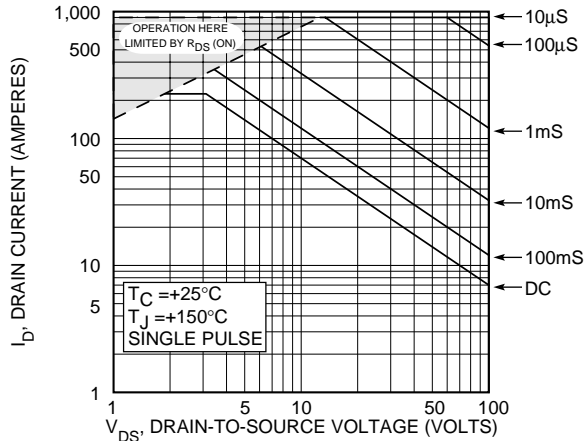


FIGURE 10, MAXIMUM SAFE OPERATING AREA

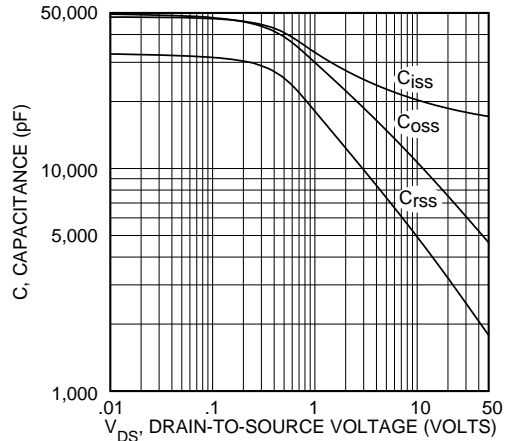


FIGURE 11, TYPICAL CAPACITANCE vs DRAIN-TO-SOURCE VOLTAGE

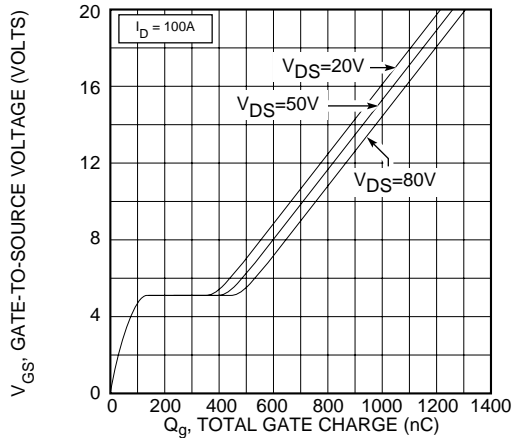


FIGURE 12, GATE CHARGES vs GATE-TO-SOURCE VOLTAGE

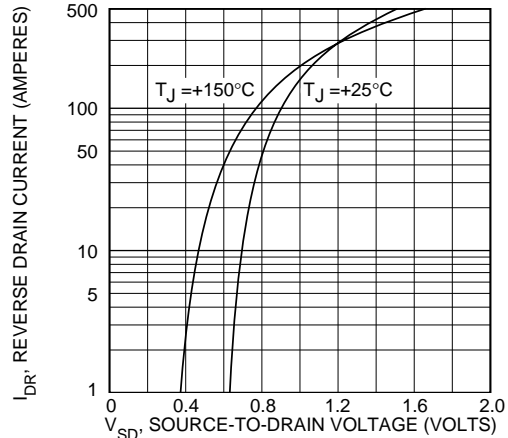
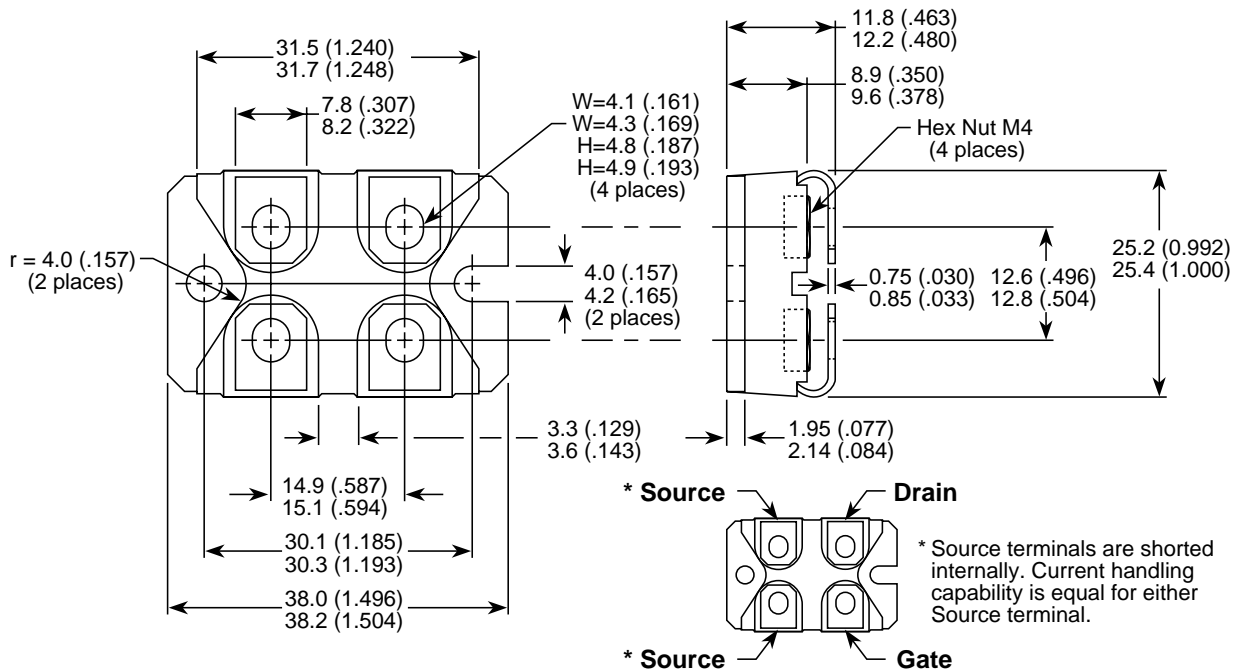


FIGURE 13, TYPICAL SOURCE-DRAIN DIODE FORWARD VOLTAGE

SOT-227 (ISOTOP®) Package Outline



Dimensions in Millimeters and (Inches)